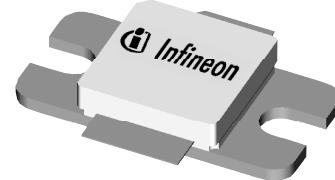


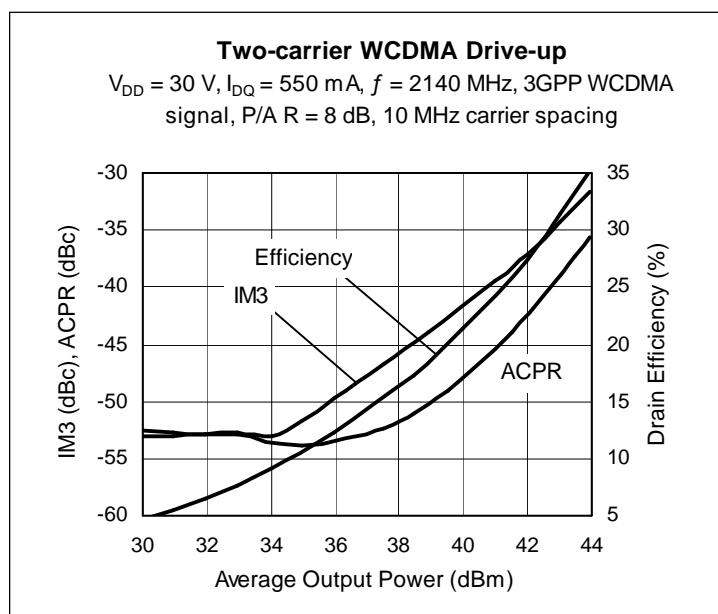
## Thermally-Enhanced High Power RF LDMOS FET 70 W, 2110 – 2170 MHz

### Description

The PTFA210701E is a thermally-enhanced, 70-watt, internally-matched *GOLDMOS®* FET intended for WCDMA applications. It is characterized for single- and two-carrier WCDMA operation from 2110 to 2170 MHz. Thermally-enhanced packaging provides the coolest operation available. Full gold metallization ensures excellent device lifetime and reliability.



PTFA210701E  
Package H-30265-2



### Features

- Thermally-enhanced packages, Pb-free and RoHS-compliant
- Broadband internal matching
- Typical two-carrier WCDMA performance at 2140 MHz, 30 V
  - Average output power = 42 dBm
  - Linear Gain = 16.5 dB
  - Efficiency = 27.0%
  - Intermodulation distortion = -37 dBc
  - Adjacent channel power = -42.5 dBc
- Typical CW performance, 2170 MHz, 30 V
  - Output power at P-1dB = 80 W
  - Efficiency = 58%
- Integrated ESD protection: Human Body Model, Class 2 (minimum)
- Excellent thermal stability, low HCl drift
- Capable of handling 10:1 VSWR @ 30 V, 70 W (CW) output power

### RF Characteristics

#### WCDMA Measurements (tested in Infineon test fixture)

$V_{DD} = 30\text{ V}$ ,  $I_{DQ} = 550\text{ mA}$ ,  $P_{OUT} = 18\text{ W}$  average

$f_1 = 2135\text{ MHz}$ ,  $f_2 = 2145\text{ MHz}$ , 3GPP signal, channel bandwidth = 3.84 MHz, peak/average = 8 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	$G_{ps}$	15.5	16.5	—	dB
Drain Efficiency	$\eta_D$	28	29	—	%
Intermodulation Distortion	IMD	—	-36.5	-35.5	dBc

All published data at  $T_{CASE} = 25^\circ\text{C}$  unless otherwise indicated

**ESD:** Electrostatic discharge sensitive device—observe handling precautions!

## RF Characteristics (cont.)

**Two-tone Measurements** (not subject to production test—verified by design/characterization in Infineon test fixture)

$V_{DD} = 30 \text{ V}$ ,  $I_{DQ} = 550 \text{ mA}$ ,  $P_{OUT} = 70 \text{ W PEP}$ ,  $f = 2140 \text{ MHz}$ , tone spacing = 1 MHz

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	$G_{ps}$	—	16.5	—	dB
Drain Efficiency	$\eta_D$	—	41	—	%
Intermodulation Distortion	IMD	—	-29.5	—	dBc

## DC Characteristics

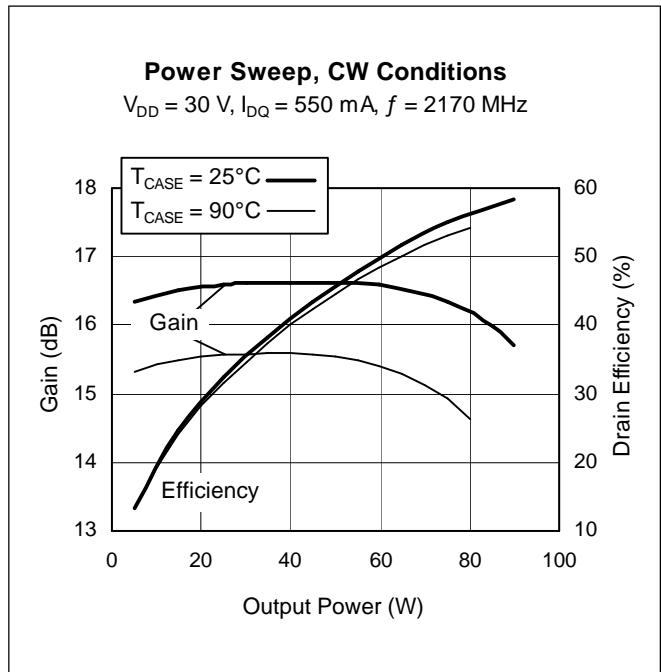
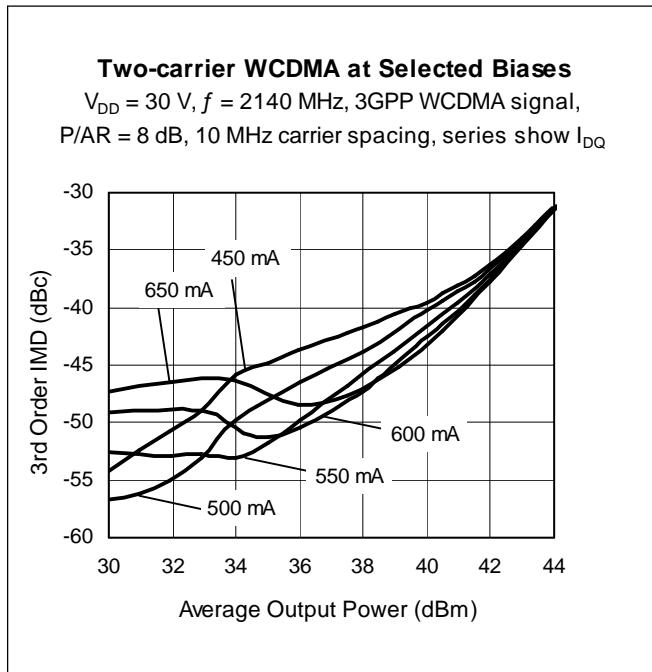
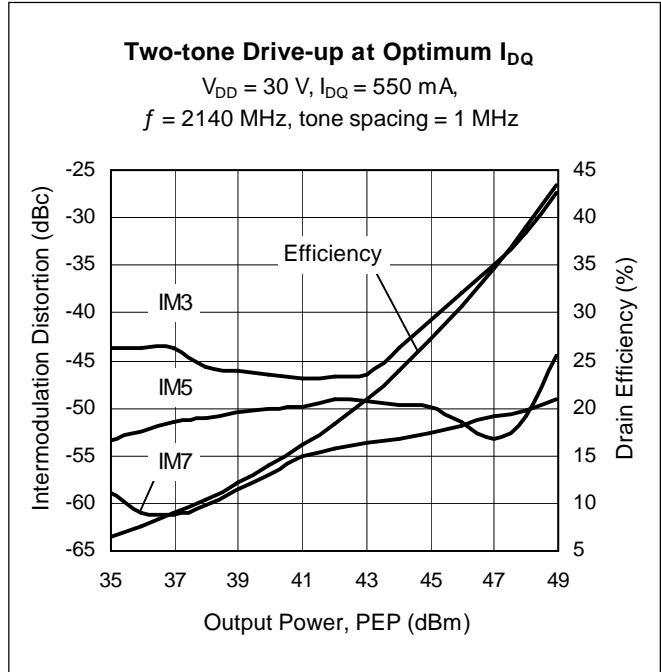
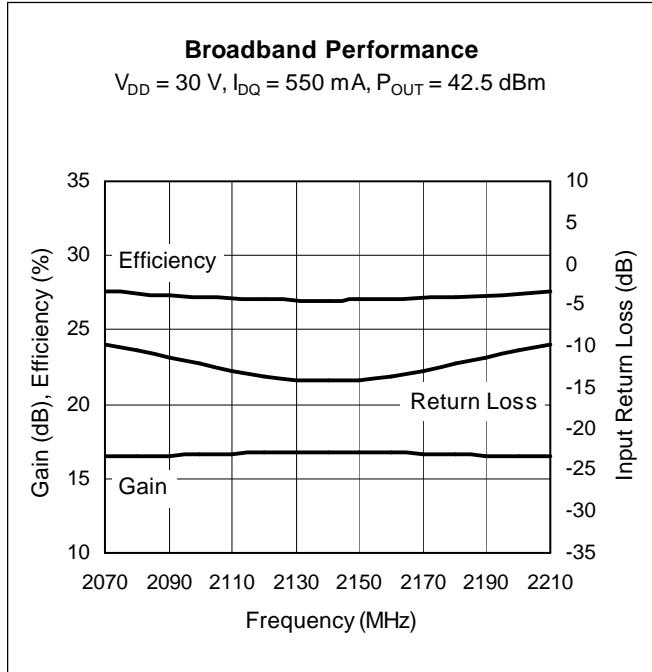
Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$ , $I_{DS} = 10 \text{ mA}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28 \text{ V}$ , $V_{GS} = 0 \text{ V}$	$I_{DSS}$	—	—	1.0	$\mu\text{A}$
	$V_{DS} = 63 \text{ V}$ , $V_{GS} = 0 \text{ V}$	$I_{DSS}$	—	—	10.0	$\mu\text{A}$
On-State Resistance	$V_{GS} = 10 \text{ V}$ , $V_{DS} = 0.1 \text{ V}$	$R_{DS(on)}$	—	0.125	—	$\Omega$
Operating Gate Voltage	$V_{DS} = 30 \text{ V}$ , $I_{DQ} = 550 \text{ mA}$	$V_{GS}$	2.0	2.5	3.0	V
Gate Leakage Current	$V_{GS} = 10 \text{ V}$ , $V_{DS} = 0 \text{ V}$	$I_{GSS}$	—	—	1.0	$\mu\text{A}$

## Maximum Ratings

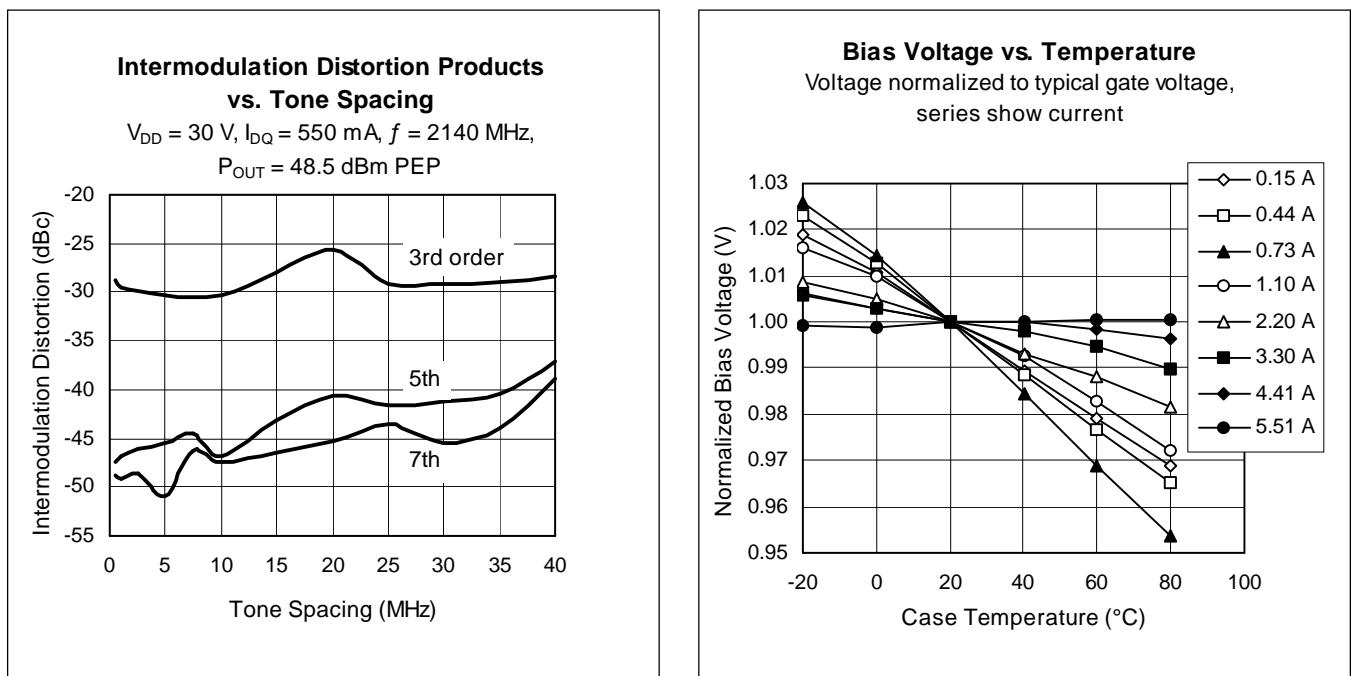
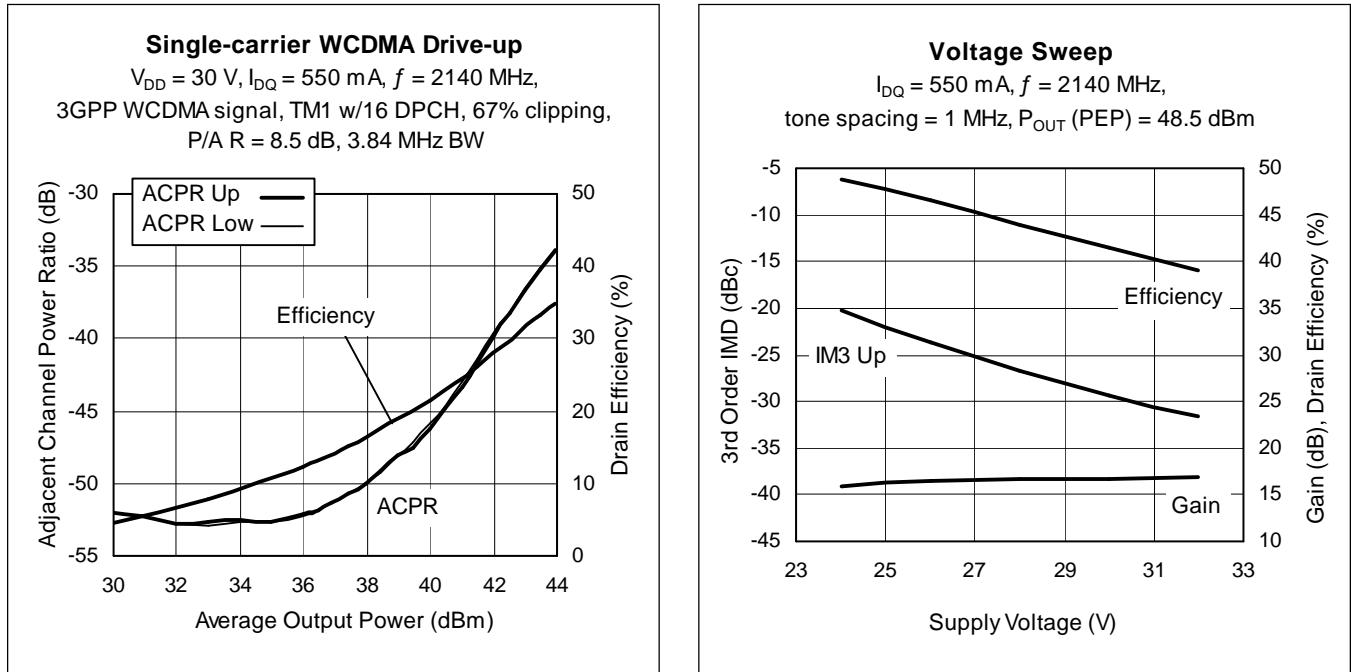
Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	V
Gate-Source Voltage	$V_{GS}$	-0.5 to +12	V
Junction Temperature	$T_J$	200	$^{\circ}\text{C}$
Total Device Dissipation	$P_D$	190	W
Above 25°C derate by		1.09	W/ $^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-40 to +150	$^{\circ}\text{C}$
Thermal Resistance ( $T_{CASE} = 70^{\circ}\text{C}$ , 70 W CW)	$R_{\theta JC}$	0.92	$^{\circ}\text{C}/\text{W}$

## Ordering Information

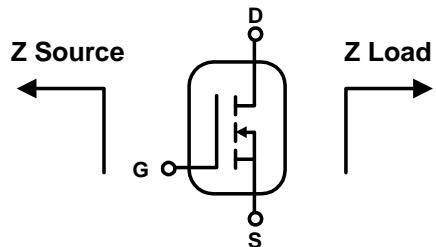
Type and Version	Package Outline	Package Description	Marking
PTFA210701E V1	H-30265-2	Thermally-enhanced slotted flange, single-ended	PTFA210701E

**Typical Performance** (data taken in a production test fixture)


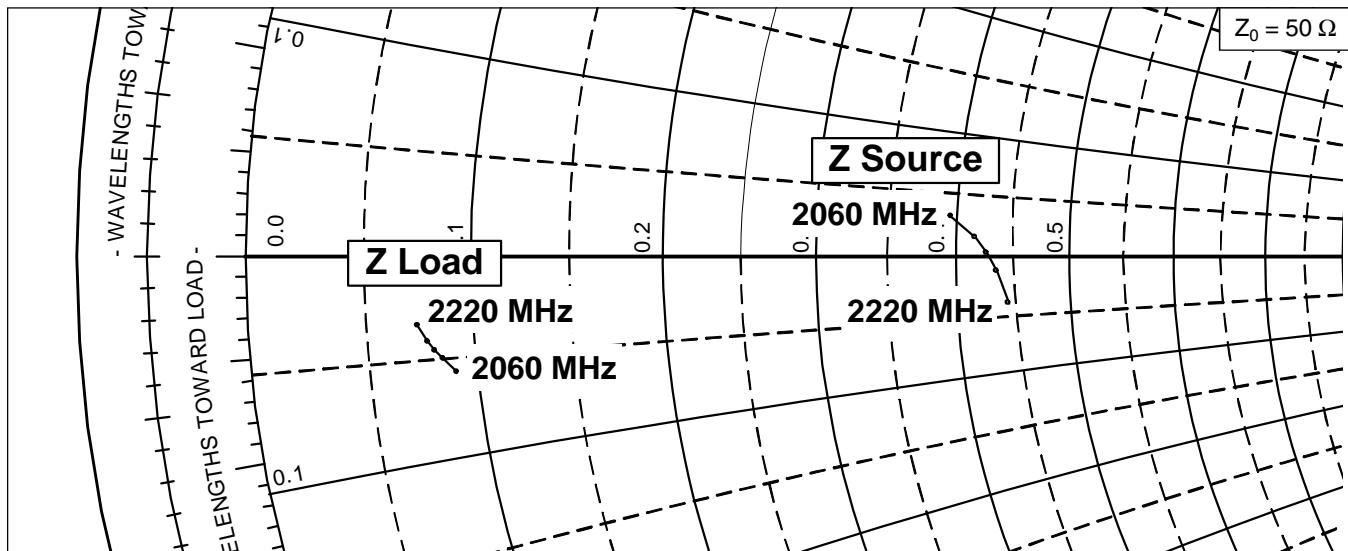
### Typical Performance (cont.)



### Broadband Circuit Impedance

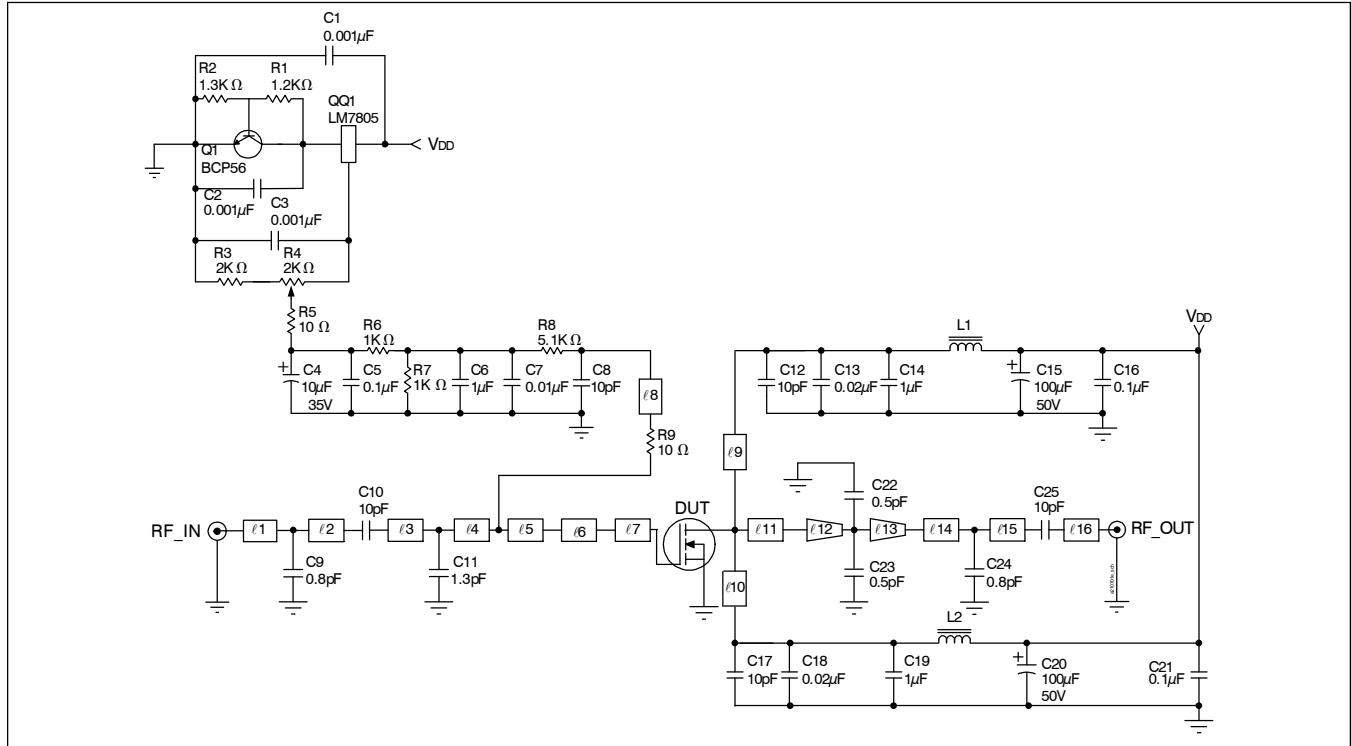


Frequency MHz	Z Source W		Z Load W	
	R	jX	R	jX
2060	19.94	1.61	4.50	-2.87
2110	20.94	0.77	4.20	-2.50
2140	21.41	0.11	4.02	-2.29
2170	21.83	-0.69	3.88	-2.07
2220	22.26	-2.09	3.66	-1.66



See next page for circuit information

## Reference Circuit



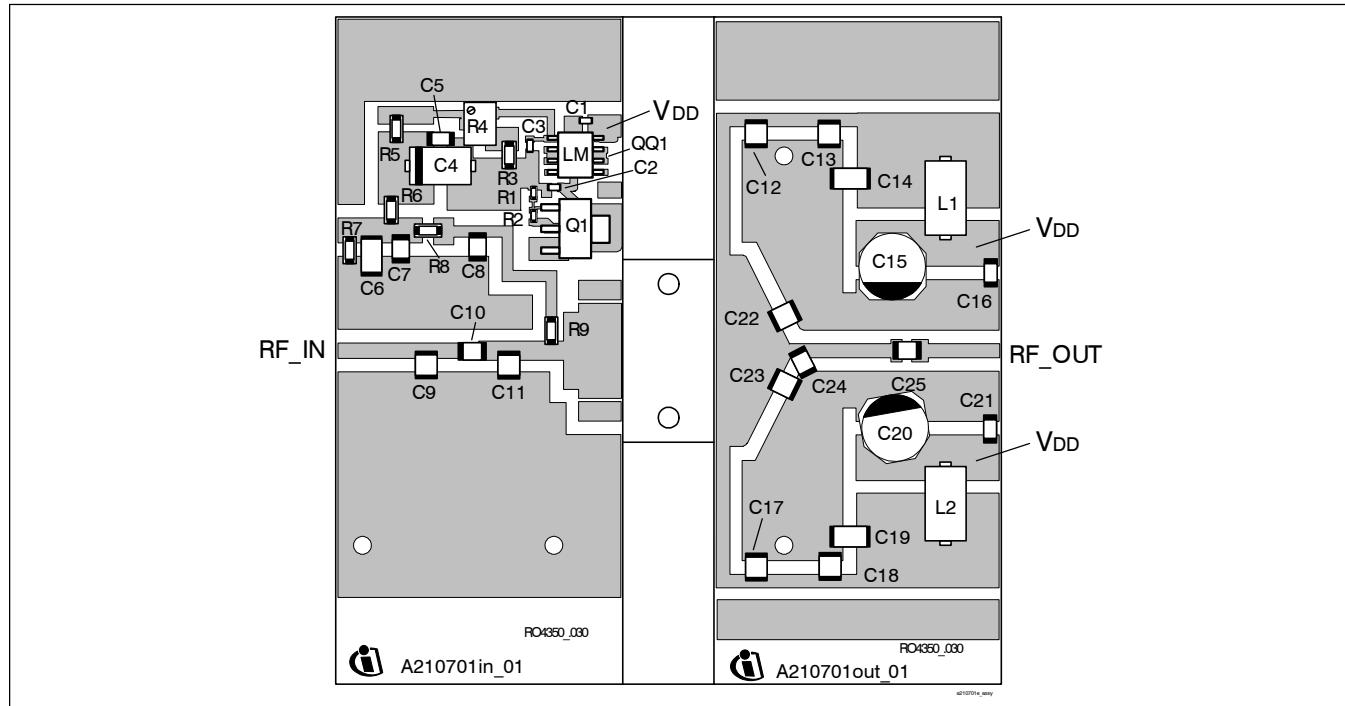
Reference circuit schematic for  $f = 2140 \text{ MHz}$

## Circuit Assembly Information

DUT	PTFA210701E	LDMOS Transistor	
PCB	0.76 mm [.030"] thick, $\epsilon_r = 3.48$	Rogers 4350	1 oz. copper

Microstrip	Electrical Characteristics at 2140 MHz <sup>1</sup>	Dimensions: L x W (mm)	Dimensions: L x W (in.)
$l_1$	$0.112 \lambda, 50.0 \Omega$	$9.53 \times 1.78$	$0.375 \times 0.070$
$l_2$	$0.053 \lambda, 50.0 \Omega$	$4.52 \times 1.78$	$0.178 \times 0.070$
$l_3$	$0.044 \lambda, 43.0 \Omega$	$3.73 \times 2.18$	$0.147 \times 0.086$
$l_4$	$0.054 \lambda, 43.0 \Omega$	$4.57 \times 2.18$	$0.180 \times 0.086$
$l_5$	$0.016 \lambda, 43.0 \Omega$	$1.37 \times 2.18$	$0.054 \times 0.086$
$l_6$	$0.022 \lambda, 14.6 \Omega$	$1.73 \times 8.76$	$0.068 \times 0.345$
$l_7$	$0.062 \lambda, 12.2 \Omega$	$4.88 \times 10.82$	$0.192 \times 0.426$
$l_8$	$0.214\lambda, 61.0 \Omega$	$18.36 \times 1.22$	$0.723 \times 0.048$
$l_9, l_{10}$	$0.211 \lambda, 50.0 \Omega$	$17.91 \times 1.57$	$0.705 \times 0.062$
$l_{11}$	$0.042 \lambda, 6.5 \Omega$	$3.25 \times 21.84$	$0.128 \times 0.860$
$l_{12}$ (taper)	$0.043 \lambda, 6.5 \Omega / 16.2 \Omega$	$3.30 \times 21.84 / 7.80$	$0.130 \times 0.860 / 0.307$
$l_{13}$ (taper)	$0.023 \lambda, 16.2 \Omega / 50.0 \Omega$	$1.88 \times 7.80 / 1.57$	$0.074 \times 0.307 / 0.062$
$l_{14}$	$0.010 \lambda, 50.0 \Omega$	$0.89 \times 1.57$	$0.035 \times 0.062$
$l_{15}$	$0.130 \lambda, 50.0 \Omega$	$11.07 \times 1.57$	$0.436 \times 0.062$
$l_{16}$	$0.116 \lambda, 50.0 \Omega$	$9.88 \times 1.57$	$0.389 \times 0.062$

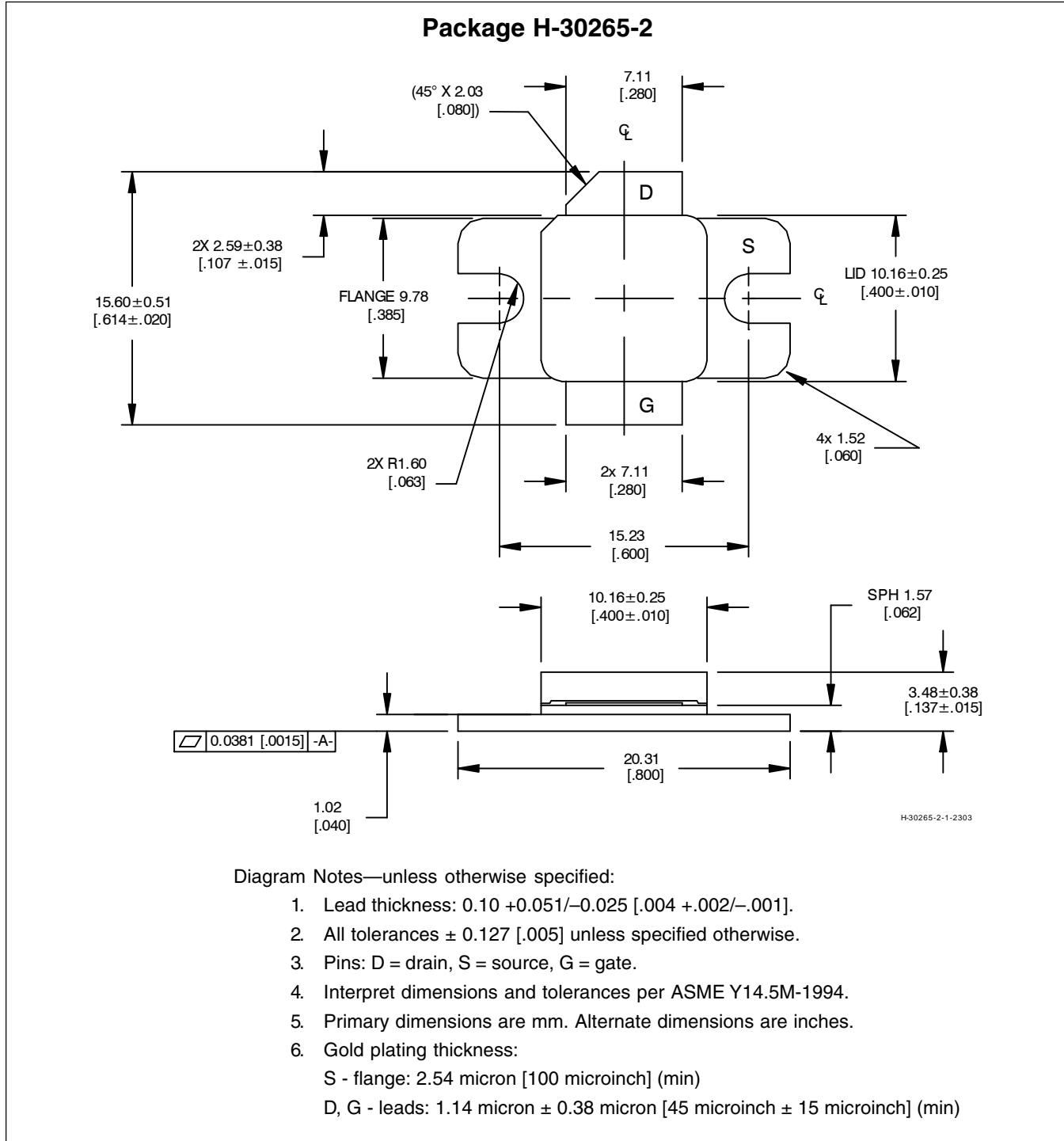
<sup>1</sup>Electrical characteristics are rounded.

**Reference Circuit (cont.)**

*Reference circuit assembly diagram (not to scale)\**

<b>Component</b>	<b>Description</b>	<b>Suggested Manufacturer</b>	<b>P/N or Comment</b>
C1, C2, C3	Capacitor, 0.001 $\mu$ F	Digi-Key	PCC1772CT-ND
C4	Tantalum capacitor, 10 $\mu$ F, 35 V	Digi-Key	399-1655-2-ND
C5, C16, C21	Capacitor, 0.1 $\mu$ F	Digi-Key	PCC104BCT-ND
C6, C14, C19	Ceramic capacitor, 1 $\mu$ F	Digi-Key	445-1411-2-ND
C7	Capacitor, 0.01 $\mu$ F	ATC	200B 103
C8, C10, C12, C17, C25	Ceramic capacitor, 10 pF	ATC	100B 100
C9, C24	Ceramic capacitor, 0.8 pF	ATC	100B 0R8
C11	Ceramic capacitor, 1.3 pF	ATC	100B 1R3
C13, C18	Capacitor, 0.02 $\mu$ F	ATC	200B 203
C15, C20	Electrolytic capacitor, 100 $\mu$ F, 50 V	Digi-Key	PCE3718CT-ND
C22, C23	Ceramic capacitor, 0.5pF	ATC	100B 0R5
L1, L2	Ferrite, 8.9 mm	Elna Magnetics	BDS 4.6/3/8.9-4S2
Q1	Transistor	Infineon Technologies	BCP56
QQ1	Voltage regulator	National Semiconductor	LM7805
R1	Chip resistor 1.2K ohms	Digi-Key	P1.2KGCT-ND
R2	Chip resistor 1.3K ohms	Digi-Key	P1.3KGCT-ND
R3	Chip resistor 2K ohms	Digi-Key	P2KECT-ND
R4	Potentiometer 2K ohms	Digi-Key	3224W-202ETR-ND
R5, R9	Chip resistor 10 ohms	Digi-Key	P10ECT-ND
R6, R7	Chip resistor 1K ohms	Digi-Key	P1KECT-ND
R8	Chip resistor 5.1K ohms	Digi-Key	P5.1KECT-ND

*\*Gerber files for this circuit available on request*

## Package Outline Specifications



Find the latest and most complete information about products and packaging at the Infineon Internet page  
<http://www.infineon.com/products>

**Revision History:** 2008-03-17

Data Sheet

Previous Version: 2006-11-10, Data Sheet

Page	Subjects (major changes since last revision)
all	Remove references to alternate Version 1.x products

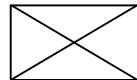
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